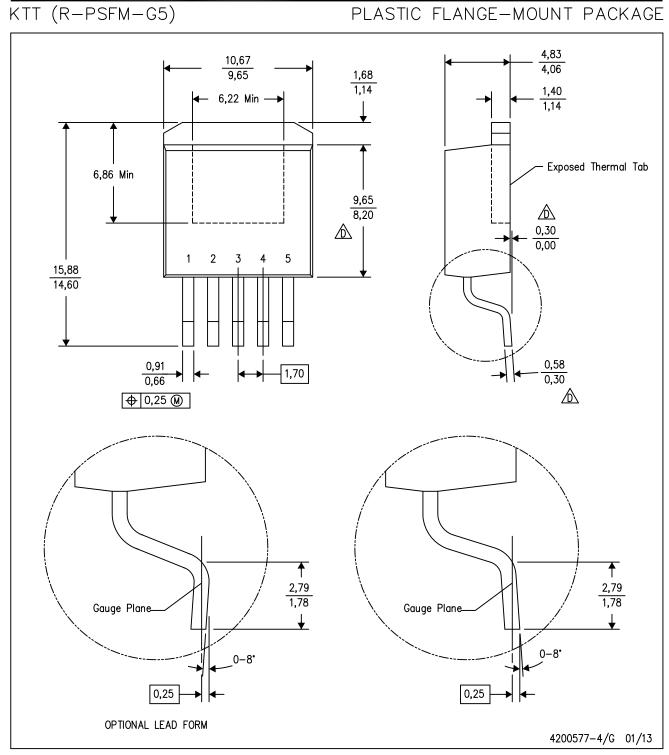
MECHANICAL DATA



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash or protrusion not to exceed 0.005 (0,13) per side.
- A Falls within JEDEC TO—263 variation BA, except minimum lead thickness, maximum seating height, and minimum body length.



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